2.5V 1:5 Dual Differential LVDS Compatible Clock Driver

Description

The MC100EP210S is a low skew 1-to-5 dual differential driver, designed with LVDS clock distribution in mind. The LVDS or LVPECL input signals are differential and the signal is fanned out to five identical differential LVDS outputs.

The EP210S specifically guarantees low output-to-output skew. Optimal design, layout, and processing minimize skew within a device and from device to device.

Two internal 50 Ω resistors are provided across the inputs. For LVDS inputs, VTA and VTB pins should be unconnected. For LVPECL inputs, VTA and VTB pins should be connected to the V_{TT} (V_{CC} – 2.0 V) supply.

Designers can take advantage of the EP210S performance to distribute low skew LVDS clocks across the backplane or the board.

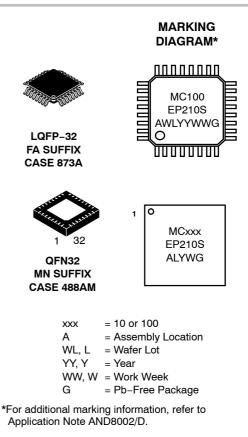
Features

- 20 ps Typical Output-to-Output Skew
- 85 ps Typical Device-to-Device Skew
- 550 ps Typical Propagation Delay
- The 100 Series Contains Temperature Compensation
- Maximum Frequency > 1 GHz Typical
- Operating Range: $V_{CC} = 2.375$ V to 2.625 V with $V_{EE} = 0$ V
- Internal 50 Ω Input Termination Resistors
- LVDS Input/Output Compatible
- These are Pb–Free Devices



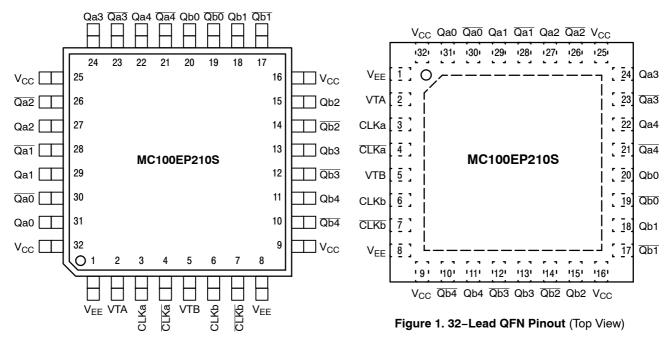
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ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 6 of this data sheet.



Warning: All V_{CC} and V_{EE} pins must be externally connected to Power Supply to guarantee proper operation.



Table 1. PIN DESCRIPTION

PIN	FUNCTION			
CLKn, CLKn	LVDS, LVPECL CLK Inputs*			
Qn0:4, Qn0:4	LVDS Outputs			
VTA	50 Ω Termination Resistors			
VTB	50 Ω Termination Resistors			
V _{CC}	Positive Supply			
V _{EE}	Ground			
EP for QFN-32, only	The Exposed Pad (EP) on the QFN–32 package bottom is thermally connected to the die for improved heat transfer out of package. The exposed pad must be attached to a heat–sinking conduit. The pad is electrically connected to V_{EE} .			

*Under open or floating conditions with input pins converging to a common termination bias voltage the device is susceptible to auto oscillation.

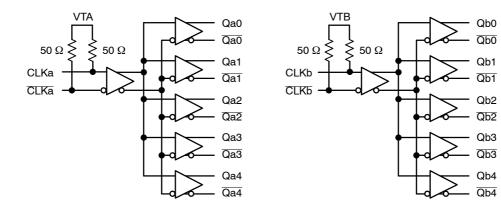


Figure 2. Logic Diagram

Table 2. ATTRIBUTES

Character	Value					
ESD Protection	> 2 kV > 100 V > 2 kV					
Moisture Sensitivity, Indefinite Time	Pb Pkg	Pb-Free Pkg				
	LQFP-32 QFN-32	Level 2	Level 2 Level 1			
Flammability Rating	UL 94 V-0 @ 0.125 in					
Transistor Count	461 D	evices				
Meets or exceeds JEDEC Spec EIA/JESD78 IC Latchup Test						

1. For additional information, refer to Application Note AND8003/D.

Table 3. MAXIMUM RATINGS

Symbol	Parameter	Condition 1	Condition 2	Rating	Unit
V _{CC}	Power Supply	V _{EE} = 0 V		6	V
V_{EE}	Power Supply (GND)	V _{CC} = 2.5 V		-6	V
VI	LVDS, LVPECL Input Voltage	V _{EE} = 0 V	$V_{I} \leq V_{CC}$	6	V
l _{out}	Output Current	Continuous Surge		50 100	mA mA
T _A	Operating Temperature Range			-40 to +85	°C
T _{stg}	Storage Temperature Range			–65 to +150	°C
θ_{JA}	Thermal Resistance (Junction-to-Ambient)	0 lfpm 500 lfpm	32 LQFP 32 LQFP	80 55	°C/W °C/W
θ_{JC}	Thermal Resistance (Junction-to-Case)	Standard Board	32 LQFP	12 to 17	°C/W
θ_{JA}	Thermal Resistance (Junction-to-Ambient)	0 lfpm 500 lfpm	QFN-32 QFN-32	31 27	°C/W °C/W
θ_{JC}	Thermal Resistance (Junction-to-Case)	2S2P	QFN-32	12	°C/W
T _{sol}	Wave Solder Pb Pb-Free			265 265	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

		-40°C		25°C			85°C				
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
I _{EE}	Power Supply Current		150	200		150	200		150	200	mA
V _{OH}	Output HIGH Voltage (Note 3)	1250	1400	1550	1250	1400	1550	1250	1400	1550	mV
V _{OL}	Output LOW Voltage (Note 3)	800	950	1100	800	950	1100	800	950	1100	mV
VIHCMR	Input HIGH Voltage Common Mode Range (Differential Configuration) (Note 4)	1.2		2.5	1.2		2.5	1.2		2.5	V
R _T	Internal Termination Resistor	43		57	43	50	57	43		57	Ω
I _{IH}	Input HIGH Current			150			150			150	μA
IIL	Input LOW Current CLK CLK	-150 -150		150 150	-150 -150		150 150	-150 -150		150 150	μΑ

Table 4. DC CHARACTERISTICS $V_{CC} = 2.5 V$, $V_{EE} = 0 V$ (Note 2)

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

2. Input and output parameters vary 1:1 with V_{CC}.

3. All loading with 100 Ω across LVDS differential outputs.

4. V_{IHCMR} min varies 1:1 with V_{EE}, V_{IHCMR} max varies 1:1 with V_{CC}. The V_{IHCMR} range is referenced to the most positive side of the differential input signal.

Table 5. AC CHARACTERISTICS V_{CC} = 2.375 to 2.625 V, V_{EE} = 0 V (Note 5)

		−40°C		25°C			85°C				
Symbol	Characteristic	Min	Тур	Max	Min	Тур	Max	Min	Тур	Max	Unit
f _{maxLVDS/} LVPECL	Maximum Frequency (See Figure 2. F _{max} /JITTER)		> 1			> 1			> 1		GHz
t _{PLH} t _{PHL}	Propagation Delay	425	525	625	450	550	650	475	575	675	ps
t _{skew}	Within-Device Skew (Note 6) Device-to-Device Skew (Note 7) Duty Cycle Skew (Note 8)		20 85 80	25 160 100		20 85 80	25 160 100		20 85 80	35 160 100	ps
t _{JITTER}	RMS Random Clock Jitter		0.2	< 1		0.2	< 1		0.2	< 1	ps
V _{PP}	Minimum Input Swing	150	800	1200	150	800	1200	150	800	1200	mV
t _r /t _f	Output Rise/Fall Time (20%-80%)	50	130	200	75	150	225	80	160	230	ps

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

5. Measured with 400 mV source, 50% duty cycle clock source. All loading with 100 Ω across differential outputs.

6. Skew is measured between outputs under identical transitions of similar paths through a device.

7. Device-to-Device skew for identical transitions at identical V_{CC} levels.

8. Duty cycle skew guaranteed only for differential operation measured from the cross point of the input to the cross point of the output.

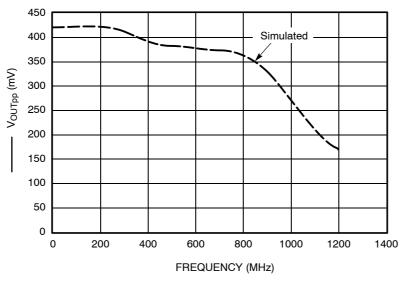


Figure 2. F_{max}

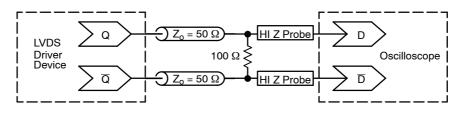


Figure 3. Typical Termination for Output Driver and Device Evaluation

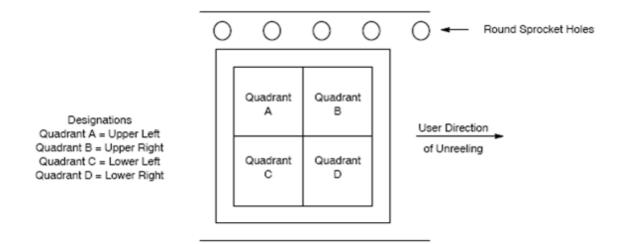


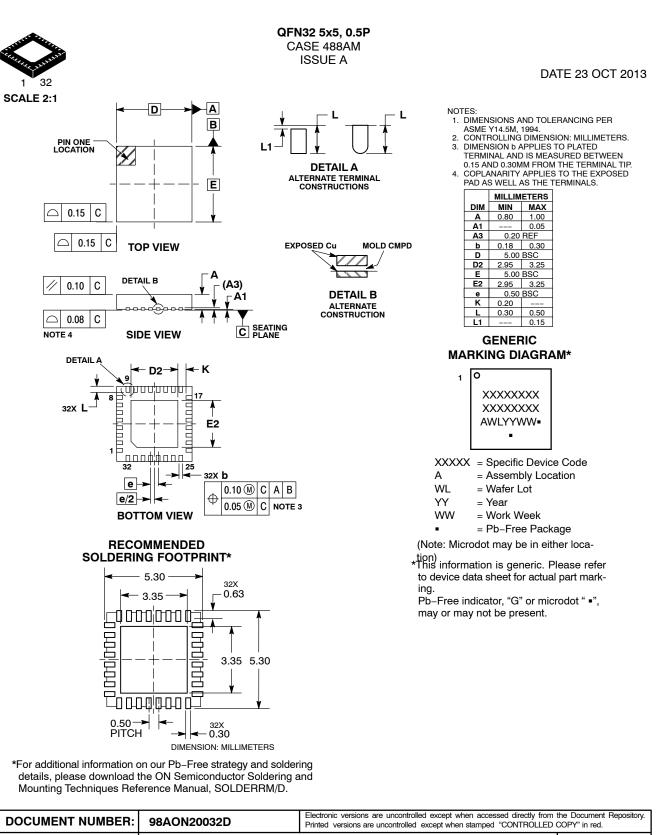
Figure 4. Tape and Reel Pin 1 Quadrant Orientation

ORDERING INFORMATION

Device	Package	Shipping [†]
MC100EP210SFAG	LQFP-32 (Pb-Free)	250 Units / Tray
MC100EP210SFAR2G	LQFP-32 (Pb-Free)	2000 / Tape & Reel (Pin 1 Orientation in Quadrant B, Figure 4)
MC100EP210SFATWG	LQFP-32 (Pb-Free)	2000 / Tape & Reel (Pin 1 Orientation in Quadrant A, Figure 4)
MC100EP210SMNG	QFN-32 (Pb-Free)	72 Units / Tray
MC100EP210SMNR4G	QFN-32 (Pb-Free)	1000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.





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DESCRIPTION:

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